inter_{sil}

40V, Low Quiescent Current, 150mA Linear Regulator

ISL80138

The ISL80138 is a high voltage, adjustable V_{OUT} low quiescent current linear regulator ideally suited for "always-on" and "keep alive" applications. The ISL80138 operates from an input voltage of +6V to +40V under normal operating conditions and consumes only 18 μ A of quiescent current at no load.

The ISL80138 features an EN pin that can be used to put the device into a low-quiescent current shutdown mode where it draws only $2\mu A$ of supply current. The device features over-temperature shutdown and current limit protection.

The ISL80138 is rated over the -40 $^\circ$ C to +125 $^\circ$ C temperature range and is available in a 14 lead HTSSOP with an exposed pad package.

TABLE 1. KEY DIFFERENCES IN FAMILY OF 40V LDO PARTS

PART NUMBER	MINIMUM IOUT	ADJ OR FIXED V _{OUT}		
ISL80136	50mA	ADJ		
ISL80138	150mA	ADJ		

Related Literature

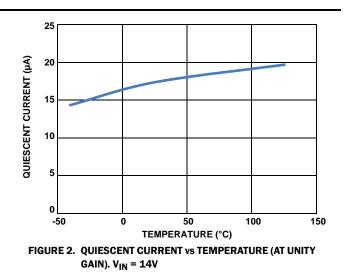
• See <u>FN7970</u>, "ISL80136 40V, Low Quiescent Current, 50mA Linear Regulator"

Features

- Wide VIN Range of 6V to 40V
- Adjustable Output Voltage from 2.5V to 12V
- Guaranteed 150mA Output Current
- Ultra Low 18µA Typical Quiescent Current
- Low 2µA of Typical Shutdown Current
- ±1% Accurate Voltage Reference
- Low Dropout Voltage of 295mV at 150mA
- 40V Tolerant Logic Level (TTL/CMOS) Enable Input
- Stable Operation with 10µF Output Capacitor
- 5kV ESD HBM Rated
- Thermal Shutdown and Current Limit Protection
- Thermally Enhanced 14 Ld Exposed Pad HTSSOP Package

Applications

- Industrial
- Telecommunications



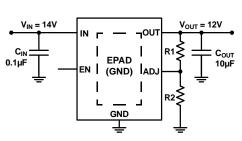
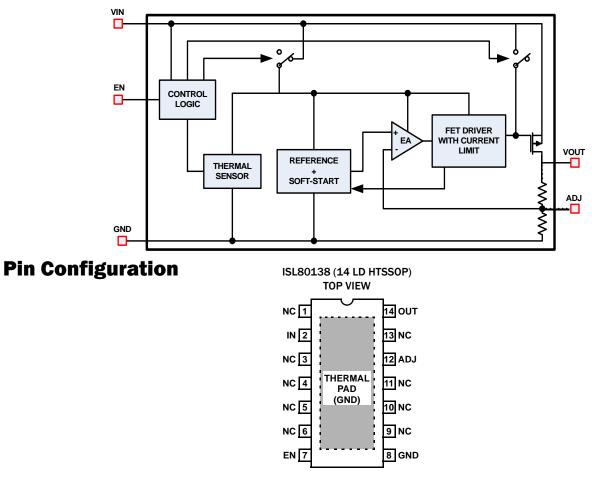


FIGURE 1. TYPICAL APPLICATION

Block Diagram



Pin Descriptions

PIN NUMBER	PIN NAME	DESCRIPTION	
1, 3, 4, 5, 6, 9, 10, 11, 13NCPins have internal termination and can be left unconnected. Connection to ground is optional.		Pins have internal termination and can be left unconnected. Connection to ground is optional.	
2	IN	Input voltage pin. A minimum 0.1µF ceramic capacitor is required for proper operation. Range 6V to 40V.	
7	EN	able pin. High on this pin enables the device. Range OV to V _{IN} .	
8	GND Ground pin.		
12	ADJ	This pin is connected to the external feedback resistor divider which sets the LDO output voltage. Range OV to 3V.	
14	OUT	Regulated output voltage. A 10µF ceramic capacitor is required for stability. Range OV to 12V.	
-	EPAD	It is recommended to solder the EPAD to the ground plane.	

Ordering Information

PART NUMBER (Notes 1, 2, 3)	PART MARKING	TEMP. RANGE (°C)	ENABLE PIN	OUTPUT VOLTAGE (V)	PACKAGE (Pb-Free)	PKG. DWG. #
ISL80138IVEAJZ	80138 IAJZ	3 IAJZ -40 to +125		ADJ	14 Ld HTSSOP	M14.173B
ISL80138EVAL1Z	1Z Evaluation Platform					

NOTES:

1. Add "-T*" suffix for tape and reel. Please refer to TB347 for details on reel specifications.

2. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

3. For Moisture Sensitivity Level (MSL), please see device information page for ISL80138. For more information on MSL please see techbrief TB363.

Absolute Maximum Ratings

IN Pin to GND Voltage	GND - 0.3V to +45V
OUT Pin to GND Voltage	GND - 0.3V to 16V
ADJ Pin to GND Voltage	GND - 0.3V to 3V
EN Pin to GND Voltage	GND - 0.3V to VIN
Output Short-circuit Duration	Indefinite
ESD Rating	
ESD Rating Human Body Model (Tested per JESD22-A114	4E) 5kV
5	,
Human Body Model (Tested per JESD22-A11	
Human Body Model (Tested per JESD22-A11 Machine Model (Tested per JESD-A115-A)	

Thermal Information

Thermal Resistance (Typical)	θ _{JA} (°C/W)	θ JC (°C∕W)
14 Ld HTSSOP Package (Notes 4, 5)	37	5
Maximum Junction Temperature		+150°C
Maximum Storage Temperature Range	6	5°C to +175°C
Pb-Free Reflow Profile		see link below
http://www.intersil.com/pbfree/Pb-FreeR	eflow.asp	

Recommended Operating Conditions

Ambient Temperature Range	-40°C to +125°C
IN pin to GND Voltage	+6V to +40V
OUT pin to GND Voltage	+2.5V to +12V
EN pin to GND Voltage	0V to +40V

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

- 4. θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.
- 5. For θ_{JC} , the "case temp" location is the center of the exposed metal pad on the package underside.

Electrical Specifications Recommended Operating Conditions, unless otherwise noted. $V_{IN} = 14V$, $I_{OUT} = 1$ mA, $C_{IN} = 0.1\mu$ F, $C_{OUT} = 10\mu$ F, $T_A = T_J = -40$ °C to +125°C, unless otherwise noted. Typical specifications are at $T_A = +25$ °C. **Boldface limits apply over the operating temperature range, -40°C to +125°C**.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 8)	ТҮР	MAX (Note 8)	UNIT
Input Voltage Range	V _{IN}		6		40	v
Guaranteed Output Current	Гоцт	$V_{IN} = V_{OUT} + VDO$	150			mA
ADJ Reference Voltage	V _{OUT}	EN = High, V _{IN} = 14V, I _{OUT} = 0.1mA to 150mA	1.211	1.223	1.235	v
Line Regulation	$\Delta V_{OUT} / \Delta V_{IN}$	$3V \le V_{IN} \le 40V$, I_{OUT} = 1mA		0.04	0.15	%
Load Regulation	$\Delta V_{OUT} / \Delta I_{OUT}$	$V_{IN} = V_{OUT} + V_{DO}$, $I_{OUT} = 100\mu A$ to 150mA		0.3	0.6	%
Dropout Voltage	∆V _{DO}	$I_{OUT} = 1 mA, V_{OUT} = 3.3V$		7	33	mV
(Note 6)		I _{OUT} = 150mA, V _{OUT} = 3.3V		380	525	mV
		$I_{OUT} = 1 mA, V_{OUT} = 5V$		7	33	mV
		I _{OUT} = 150mA, V _{OUT} = 5V		295	460	mV
Shutdown Current	I _{SHDN}	EN = LOW		2	3.64	μA
Quiescent Current	IQ	EN = HIGH, I _{OUT} = 0mA		18	24	μA
		EN = HIGH, I _{OUT} = 1mA		22	42	μA
		EN = HIGH, I _{OUT} = 10mA		34	60	μA
		EN = HIGH, I _{OUT} = 150mA		90	125	μA
Power Supply Rejection Ratio	PSRR	f = 100Hz; V _{IN_RIPPLE} = 500mV _{P-P} ; Load = 150mA		66		dB
EN FUNCTION	1			1		
EN Threshold Voltage	V _{EN_H}	V _{OUT} = Off to On			1.485	v
	V _{EN_L}	V _{OUT} = On to Off	0.975			v
EN Pin Current	I _{EN}	V _{OUT} = 0V		0.026		μA
EN to Regulation Time (Note 7)	t _{EN}			1.65	1.93	ms

Electrical Specifications Recommended Operating Conditions, unless otherwise noted. $V_{IN} = 14V$, $I_{OUT} = 1$ mA, $C_{IN} = 0.1\mu$ F, $C_{OUT} = 10\mu$ F, $T_A = T_J = -40$ °C to +125 °C, unless otherwise noted. Typical specifications are at $T_A = +25$ °C. **Boldface limits apply over the operating temperature range, -40** °C to +125 °C. (Continued)

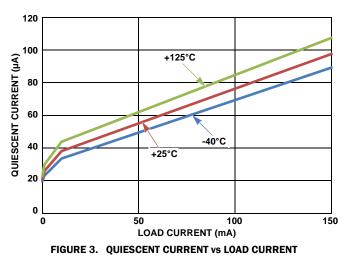
PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 8)	ТҮР	MAX (Note 8)	UNIT
PROTECTION FEATURE	S					
Output Current Limit	ILIMIT	V _{OUT} = 0V	175	410		mA
Thermal Shutdown	T _{SHDN}	Junction Temperature Rising		+165		°C
Thermal Shutdown Hysteresis	T _{HYST}			+20		°C

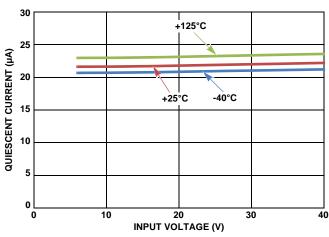
NOTES:

6. Dropout voltage is defined as $(V_{IN} - V_{OUT})$ when V_{OUT} is 2% below the value of V_{OUT} when $V_{IN} = V_{OUT} + 3V$.

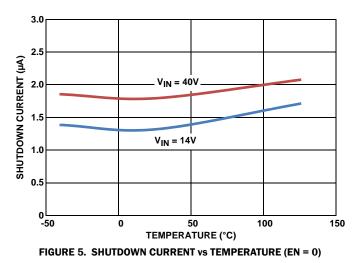
- 7. Enable to Regulation is the time the output takes to reach 95% of its final value with V_{IN} = 14V and EN is taken from V_{IL} to V_{IH} in 5ns. For the adjustable versions, the output voltage is set at 5V.
- 8. Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.

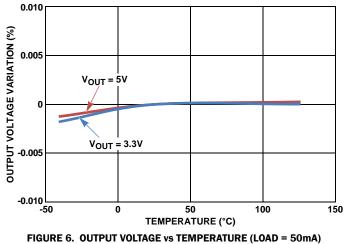
Typical Performance Curves $v_{IN} = 14V$, $I_{OUT} = 1mA$, $v_{OUT} = 5V$, $T_J = +25$ °C, unless otherwise specified.

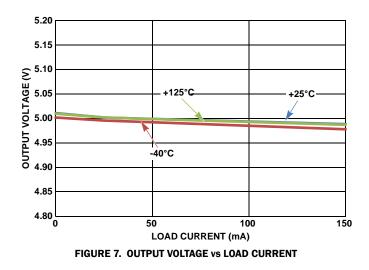












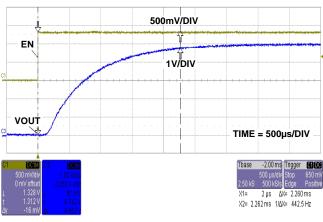
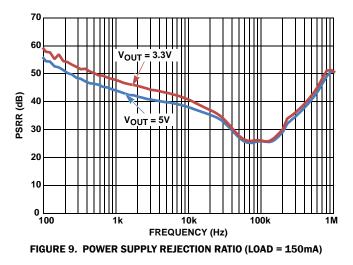


FIGURE 8. START-UP WAVEFORM

Typical Performance Curves $V_{IN} = 14V$, $I_{OUT} = 1mA$, $V_{OUT} = 5V$, $T_J = +25^{\circ}C$, unless otherwise specified. (Continued)



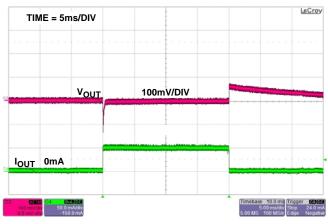


FIGURE 10. LOAD TRANSIENT RESPONSE

Functional Description

Functional Overview

The ISL80138 is a high performance, high voltage, low-dropout regulator (LDO) with 150mA sourcing capability. The part is rated to operate over the -40 °C to +125 °C temperature range. Featuring ultra-low quiescent current, it is an ideal choice for "always-on" applications. It works well under a "load dump condition" where the input voltage could rise up to 40V. This LDO device also features current limit and thermal shutdown protection.

Enable Control

The ISL80138 has an enable pin, which turns the device on when pulled high. When EN is low, the IC goes into shutdown mode and draws less than 2μ A. In "always-on" applications, EN can be tied to IN.

Current Limit Protection

The ISL80138 has internal current limiting functionality to protect the regulator during fault conditions. During current limit, the output sources a fixed amount of current largely independent of the output voltage. If the short or overload is removed from V_{OUT} , the output returns to normal voltage regulation mode.

Thermal Fault Protection

In the event that the die temperature exceeds a typical value of +165°C, the output of the LDO will shut down until the die temperature cools down to a typical +145°C. The level of power dissipated, combined with the ambient temperature and the thermal impedance of the package, determines if the junction temperature exceeds the thermal shutdown temperature. See the "Power Dissipation" section on page 7 for more details.

Application Information

Input and Output Capacitors

A minimum 0.1μ F ceramic capacitor is recommended at the input for proper operation. For the output, a ceramic capacitor with a capacitance of 10μ F is recommended for the ISL80138 to maintain stability. The ground connection of the output capacitor should be routed directly to the GND pin of the device and also placed close to the IC.

Output Voltage Setting

The ISL80138 output voltage is programmed using an external resistor divider as shown in Figure 11.

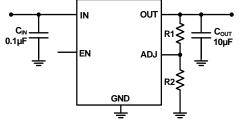


FIGURE 11. OUTPUT VOLTAGE SETTING

The output voltage is calculated using Equation 1:

$$V_{OUT} = 1.223 V \times \left(\frac{R_1}{R_2} + 1\right)$$
 (EQ. 1)

Power Dissipation

The junction temperature must not exceed the range specified in "Recommended Operating Conditions" on page 3. The power dissipation can be calculated using Equation 2:

$$P_{D} = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND}$$
(EQ. 2)

The maximum allowable junction temperature, $T_{J(MAX)}$ and the maximum expected ambient temperature, $T_{A(MAX)}$ will determine the maximum allowable junction temperature rise (ΔT_J) , as shown in Equation 3:

$$\Delta T_{J} = T_{J(MAX)} - T_{A(MAX)}$$
(EQ. 3)

To calculate the maximum ambient operating temperature, use the junction-to-ambient thermal resistance (θ_{JA}) as shown in Equation 4:

$$T_{J(MAX)} = P_{D(MAX)} \times \theta_{JA} + T_{A}$$
(EQ. 4)

Board Layout Recommendations

A good PCB layout is important to achieve expected performance. Consideration should be taken when placing the components and routing the trace to minimize the ground impedance and keep the parasitic inductance low. The input and output capacitors should have a good ground connection and be placed as close to the IC as possible. The feedback trace in the adjustable version should be away from other noisy traces. The 14 Ld HTSSOP package uses the copper area on the PCB as a heat-sink. The EPAD of this package must be soldered to the copper plane (GND plane) for effective heat dissipation. Figure 12 shows a curve for θ_{JA} of the package for different copper area sizes.

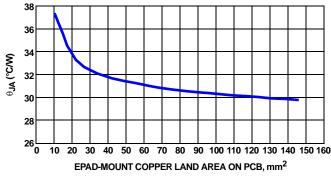


FIGURE 12. θ_{JA} vs epad-mount copper land area on PCB

Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest Rev.

DATE REVISION		CHANGE
January 11, 2012	FN7969.0	Initial Release.

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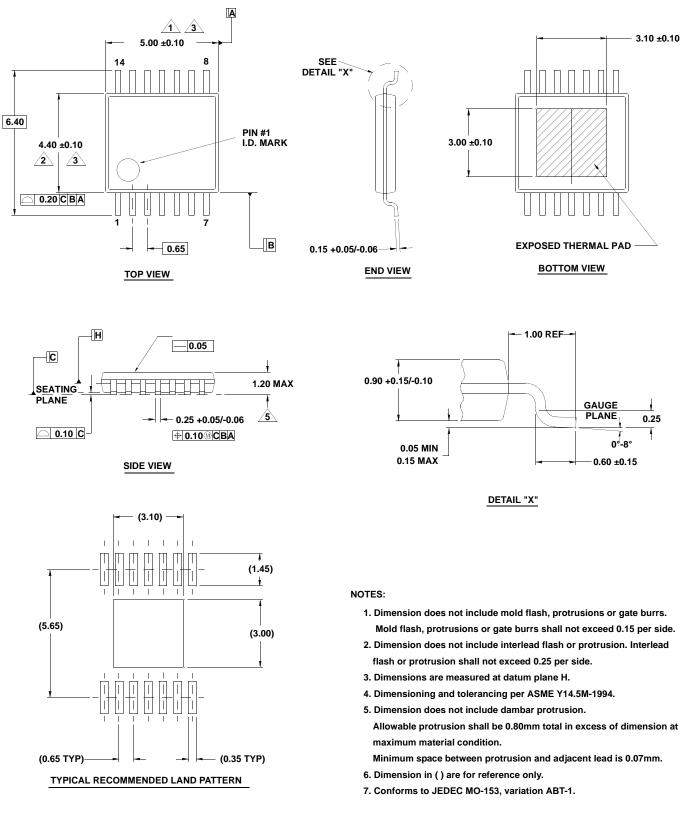
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Package Outline Drawing

M14.173B

14 LEAD HEAT-SINK THIN SHRINK SMALL OUTLINE PACKAGE (HTSSOP) Rev 1, 1/10



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